# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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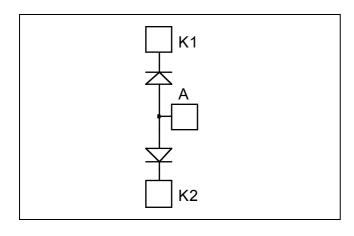
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

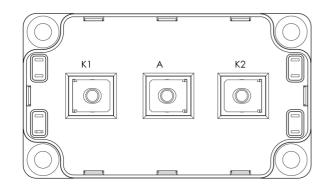




# APTDF400AA20G

# Dual Common Anode diodes Power Module





# $V_{RRM} = 200V$ $I_{C} = 400A$ @ Tc = 80°C

#### Application

- Uninterruptible Power Supply (UPS)
- Induction heating
- Welding equipment
- High speed rectifiers

#### Features

- Ultra fast recovery times
- Soft recovery characteristics
- High blocking voltage
- High current
- Low leakage current
- Very low stray inductance
  - Symmetrical design
  - M5 power connectors
- High level of integration

#### Benefits

- Outstanding performance at high frequency operation
- Low losses
- Low noise switching
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- RoHS Compliant

### Absolute maximum ratings

Symbol	Parameter			Max ratings	Unit	
V <sub>R</sub>	Maximum DC reverse Voltage			200	V	
V <sub>RRM</sub>	Maximum Peak Repetitive Revers	e Voltage		200	v	
I <sub>F(AV)</sub>	Maximum Average Forward	Duty cycle = 50%	$T_C = 25^{\circ}C$	500		
	Current	Duty Cycle – 5078	$T_C = 80^{\circ}C$	400	А	
I <sub>F(RMS)</sub>	RMS Forward Current	Duty cycle = 50%	$T_C = 45^{\circ}C$	500	11	
I <sub>FSM</sub>	Non-Repetitive Forward Surge Cu	rrent 8.3ms	$T_C = 45^{\circ}C$	3000		

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

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### All ratings (a) $T_j = 25^{\circ}C$ unless otherwise specified

### **Electrical Characteristics**

Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit
$V_{\rm F}$	Diode Forward Voltage	$I_{\rm F} = 400 {\rm A}$			1.0	1.1	
		$I_F = 800A$			1.4		V
		$I_{\rm F} = 400 {\rm A}$	$T_{j} = 125^{\circ}C$		0.9		
I <sub>RM</sub>	Maximum Reverse Leakage Current	$V_{R} = 200V \qquad \frac{T_{i} = 25^{\circ}C}{T_{j} = 125^{\circ}C}$			750	۸	
			$T_{j} = 125^{\circ}C$			1000	μA
CT	Junction Capacitance	$V_R = 200V$			1600		pF

### **Dynamic Characteristics**

Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit
t <sub>rr</sub>	Reverse Recovery Time	$I_F=1A, V_R=30V$ di/dt = 400A/ $\mu$ s	$T_j = 25^{\circ}C$		39		ns
t <sub>rr</sub>	Reverse Recovery Time	$I_{\rm F} = 400 \text{A}$ $V_{\rm R} = 133 \text{V}$	$T_j = 25^{\circ}C$		60		- ns
۲r			$T_{j} = 125^{\circ}C$		110		
Q <sub>rr</sub>	Reverse Recovery Charge		$T_j = 25^{\circ}C$		800		nC
Qrr	Reverse Recovery Charge	$v_{\rm R} = 133 v$ di/dt = 800A/µs	$T_{j} = 125^{\circ}C$		3360		ne
I	Reverse Recovery Current		$T_j = 25^{\circ}C$		24		А
I <sub>RRM</sub>	Reverse Recovery Current		$T_{j} = 125^{\circ}C$		60		А
t <sub>rr</sub>	Reverse Recovery Time	$I_{F} = 400A$ $V_{R} = 133V$ $di/dt = 4000A/\mu s$			80		ns
Qn	Reverse Recovery Charge		$T_j = 125^{\circ}C$		7.64		μC
I <sub>RRM</sub>	Reverse Recovery Current				176		А

## Thermal and package characteristics

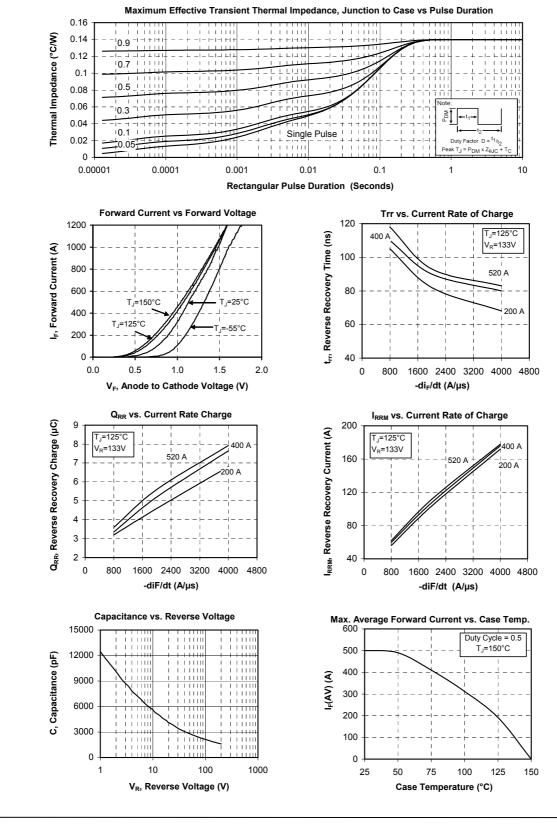
Symbol	Characteristic			Min	Тур	Max	Unit
R <sub>thJC</sub>	Junction to Case Thermal Resistance					0.14	°C/W
VISOL	RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz			4000			V
T <sub>J</sub>	Operating junction temperature range			-40		150	°C
T <sub>STG</sub>	Storage Temperature Range -			-40		125	
T <sub>C</sub>	Operating Case Temperature			-40		100	
Torque	Mounting torque	To heatsink	M6	3		5	N.m
	Mounting torque	For terminals	M5	2		3.5	19.111
Wt	Package Weight					300	g

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# APTDF400AA20G

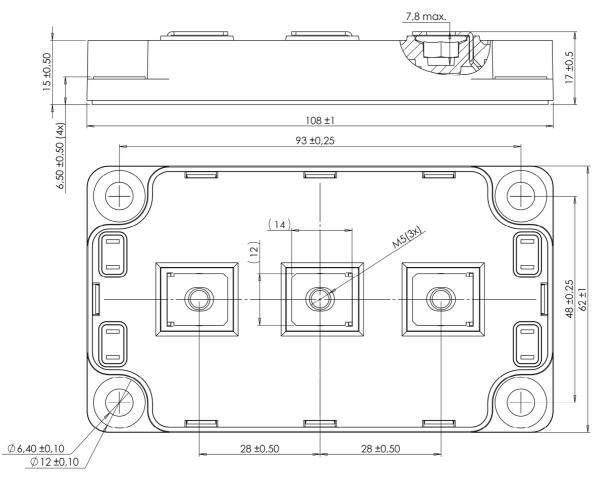
#### **Typical Performance Curve**



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### SP6 Package outline (dimensions in mm)





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